



# Product Change Notification

**Change Notification #:** 118992-00  
**Change Title:** Intel® Server System R2208WFTZSR,  
PCN 118992-00, Product Design, Product  
Material  
Adding Second Source Component Updates  
**Date of Publication:** March 23, 2022

## Key Characteristics of the Change:

Product Design, Product Material

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material*</b>	April 16, 2022
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is implementing the following changes on the items listed in the "Products Affected" table.

\*\*Adding a second source for the Over Current Protection (OCP) Integrated Circuit (IC) on the Server Board. The new IC is identical in form factor and function to the previous one.

- As a result, we are adding as alternates the following PBA: M71660-951/-961.

\*\*Adding a second source for a Voltage Regulator (VR) controller on the Hot swap backplane (HSBP). The new controller is identical in function to the previous one but differs in form factor.

- As a result, we are adding as alternate the following Hot swap backplane PBA: H88386-301.  
Also, using the interposer PCB supporting a new Programmable System-On-Chip (PSOC) and the second source for a Voltage Regulator Controller, we have the following PBA: H88386-311 being added as alternate.

All the new components have passed all functional and electrical validation tests successfully.

## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

## Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® Server System R2208WFTZSR, Single	R2208WFTZSR	986049	M55876-001	M57999-961 M57999-951 H88386-252 H88386-253	M55876-002	M57999-961 M57999-951 M71660-951 M71660-961 H88386-252 H88386-253 H88386-301 H88386-311

## PCN Revision History:

**Date of Revision:**

March 23, 2022

**Revision Number:**

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**Reason:**

Originally Published PCN



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## 118992-00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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